

# HAT2179R

Silicon N Channel MOS FET  
High Speed Power Switching

REJ03G1570-0200

Rev.2.00

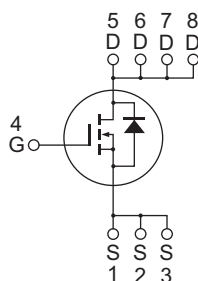
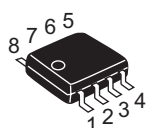
Jul 17, 2009

## Features

- Low on-resistance
- Low drive current
- High density mounting

## Outline

RENESAS Package code: PRSP0008DD-D  
(Package name: SOP-8<FP-8DAV>)



1, 2, 3 Source  
4 Gate  
5, 6, 7, 8 Drain

## Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	600	V
Gate to source voltage	$V_{GSS}$	$\pm 30$	V
Drain current	$I_D$	0.7	A
Drain peak current	$I_{D(pulse)}$ <sup>Note1</sup>	2.0	A
Body-drain diode reverse drain current	$I_{DR}$	0.7	A
Body-drain diode reverse drain peak current	$I_{DR(pulse)}$ <sup>Note1</sup>	2.0	A
Channel dissipation	$P_{ch}$ <sup>Note2</sup>	2.5	W
Channel temperature	$T_{ch}$	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C

Notes: 1.  $PW \leq 10 \mu s$ , duty cycle  $\leq 1\%$

2. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm),  $PW \leq 10 s$

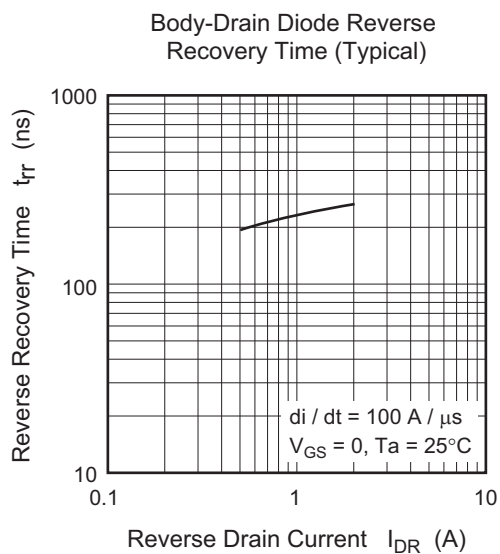
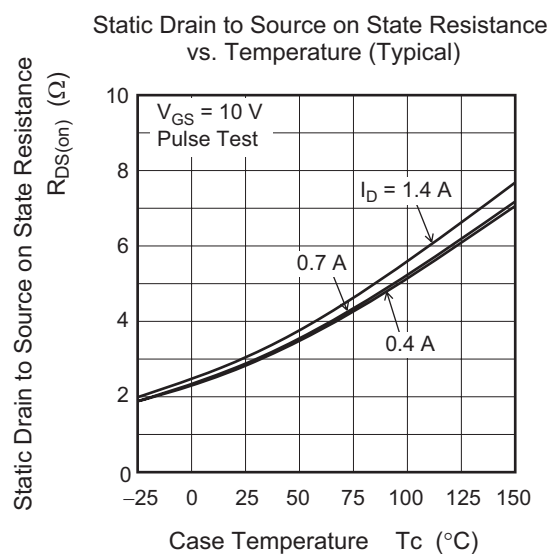
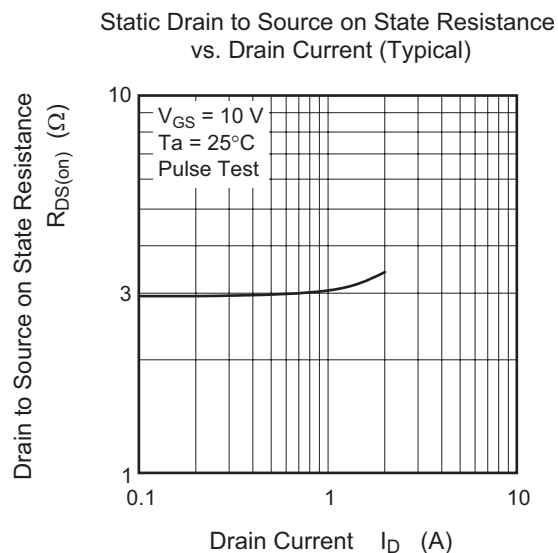
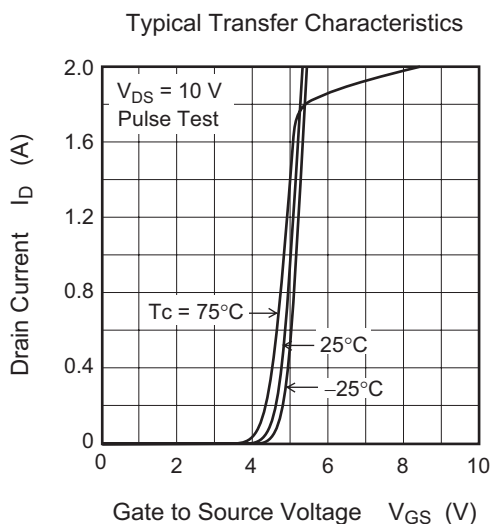
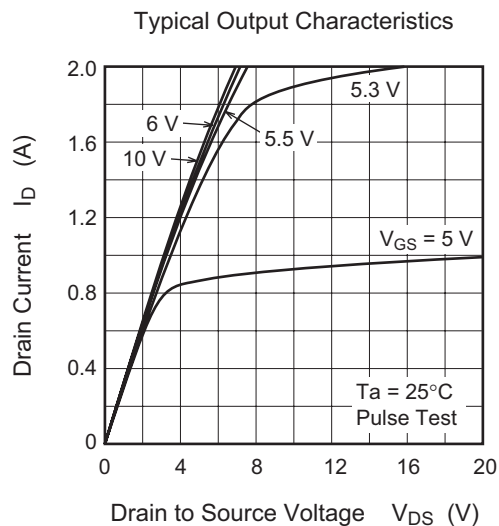
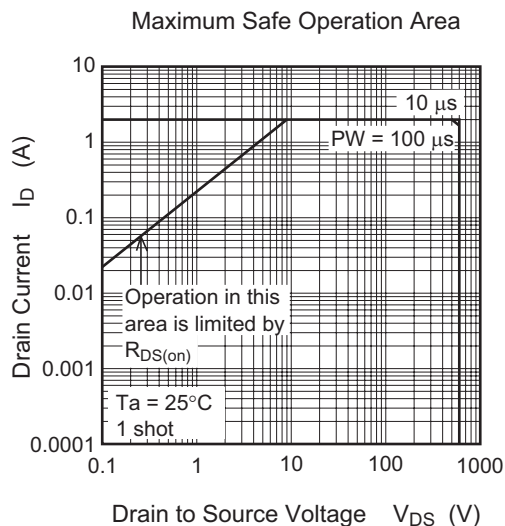
## Electrical Characteristics

(Ta = 25°C)

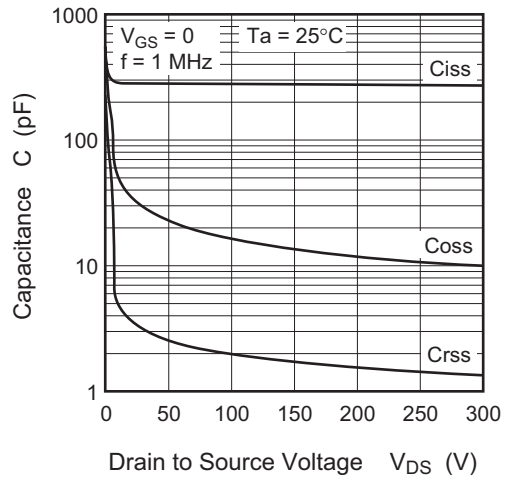
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	600	—	—	V	$I_D = 10 \text{ mA}$ , $V_{GS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	1	$\mu\text{A}$	$V_{DS} = 600 \text{ V}$ , $V_{GS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	$\pm 0.1$	$\mu\text{A}$	$V_{GS} = \pm 30 \text{ V}$ , $V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	3.0	—	5.0	V	$V_{DS} = 10 \text{ V}$ , $I_D = 1 \text{ mA}$
Forward transfer admittance	$ y_{fs} $	0.8	1.2	—	S	$I_D = 0.4 \text{ A}$ , $V_{DS} = 10 \text{ V}$ <sup>Note3</sup>
Static drain to source on state resistance	$R_{DS(on)}$	—	3.5	4.5	$\Omega$	$I_D = 0.4 \text{ A}$ , $V_{GS} = 10 \text{ V}$ <sup>Note3</sup>
Input capacitance	$C_{iss}$	—	280	—	pF	$V_{DS} = 25 \text{ V}$ $V_{GS} = 0$ $f = 1 \text{ MHz}$
Output capacitance	$C_{oss}$	—	31	—	pF	
Reverse transfer capacitance	$C_{rss}$	—	3.8	—	pF	
Turn-on delay time	$t_{d(on)}$	—	24	—	ns	$I_D = 0.4 \text{ A}$ $V_{GS} = 10 \text{ V}$ $R_L = 750 \Omega$ $R_g = 10 \Omega$
Rise time	$t_r$	—	15	—	ns	
Turn-off delay time	$t_{d(off)}$	—	50	—	ns	
Fall time	$t_f$	—	58	—	ns	
Total gate charge	$Q_g$	—	10	—	nC	$V_{DD} = 480 \text{ V}$ $V_{GS} = 10 \text{ V}$ $I_D = 0.7 \text{ A}$
Gate to source charge	$Q_{gs}$	—	1.6	—	nC	
Gate to drain charge	$Q_{gd}$	—	5.4	—	nC	
Body-drain diode forward voltage	$V_{DF}$	—	0.8	1.2	V	$I_F = 0.7 \text{ A}$ , $V_{GS} = 0$ <sup>Note3</sup>
Body-drain diode reverse recovery time	$t_{rr}$	—	200	—	ns	$I_F = 0.7 \text{ A}$ , $V_{GS} = 0$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

Notes: 3. Pulse test

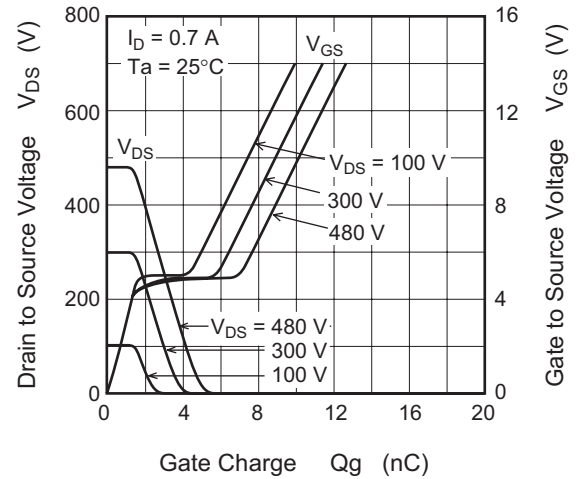
## Main Characteristics



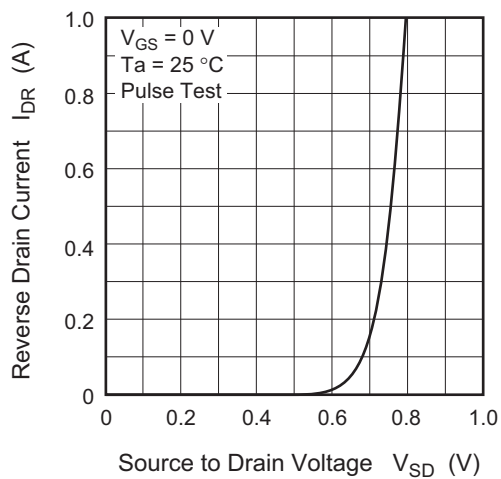
Typical Capacitance vs.  
Drain to Source Voltage



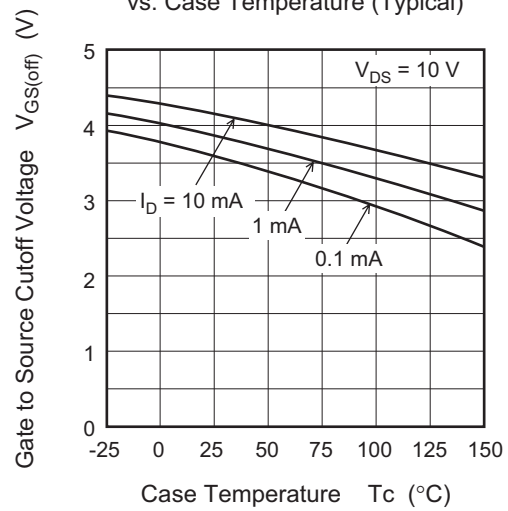
Dynamic Input Characteristics (Typical)



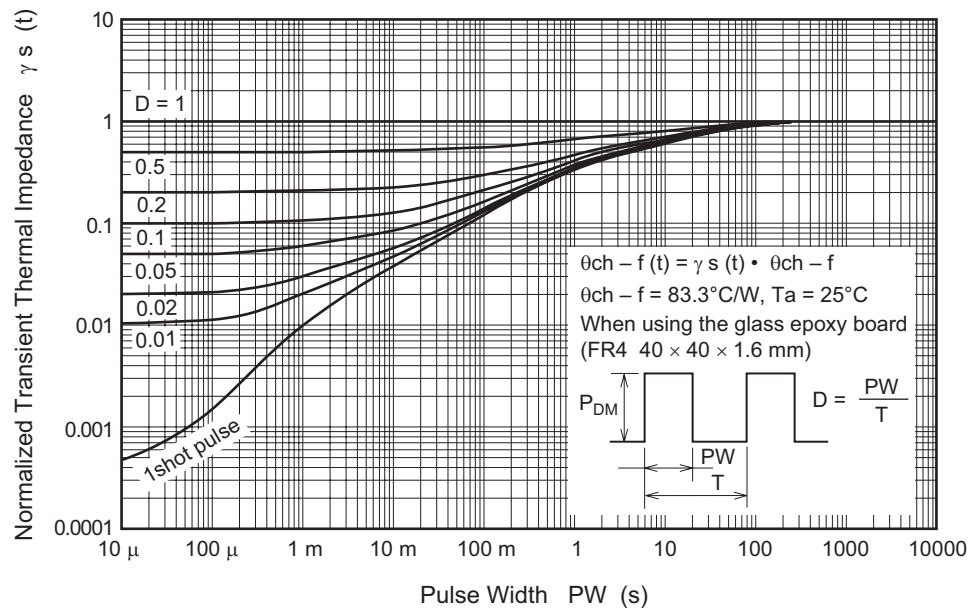
Reverse Drain Current vs.  
Source to Drain Voltage (Typical)



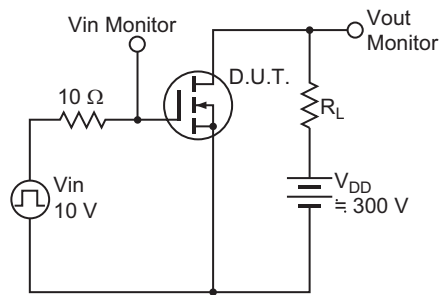
Gate to Source Cutoff Voltage  
vs. Case Temperature (Typical)



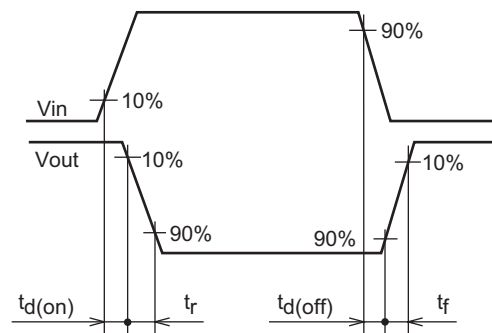
Normalized Transient Thermal Impedance vs. Pulse Width



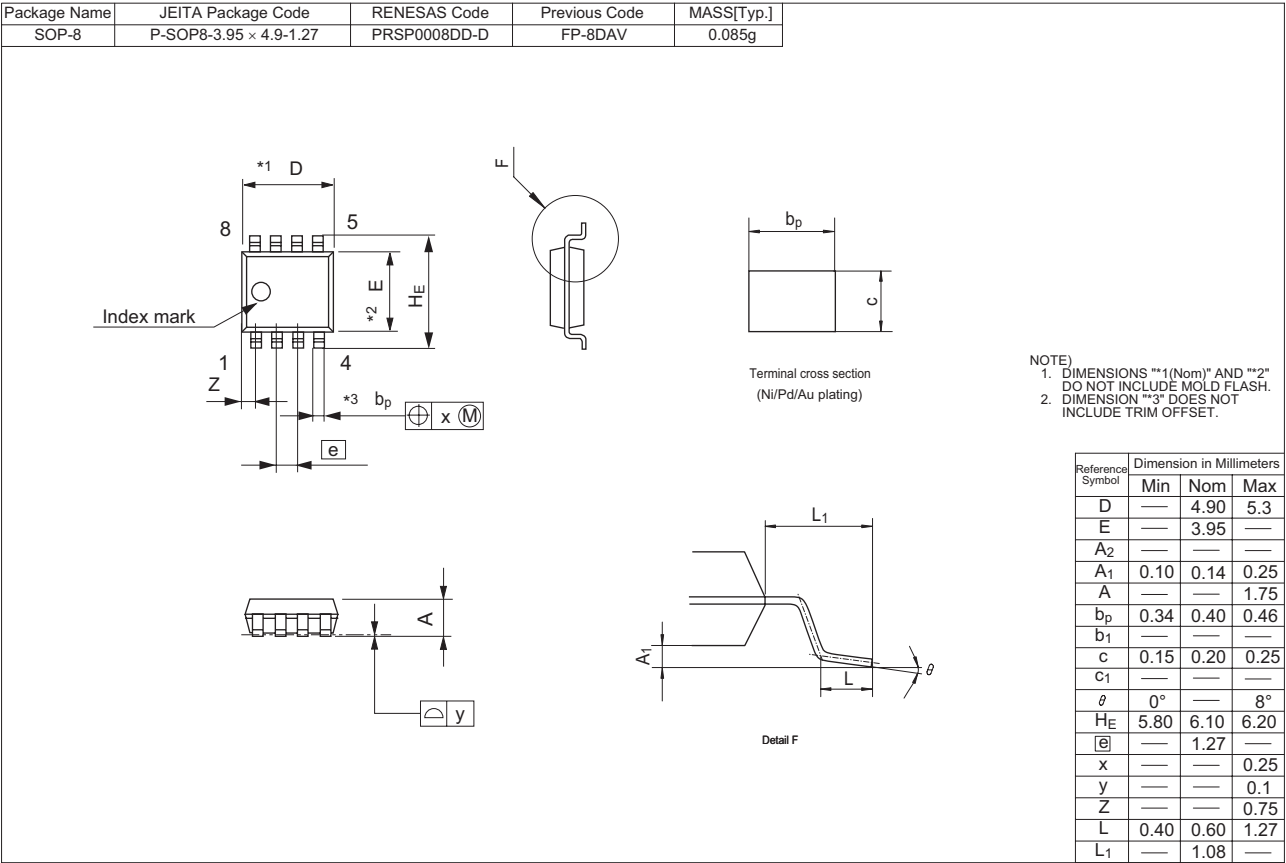
Switching Time Test Circuit



Switching Time Waveform



Package Dimensions



Ordering Information

Part No.	Quantity	Shipping Container
HAT2179R-EL-E	2500 pcs	Taping

Notes:

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